

Welcome to O-Leading

O-Leading is committed to being the partner of the one stop solution in the EMS supply chain, including PCB design, PCB manufacturing and PCB assembly (PCBA). We supply some of the most advanced PCB technologies, including HDI PCBs, multilayer PCBs, rigid-flexible PCBs. We are able to support from the rapid rotation prototype to medium and mass production. [OEM Pcb prototype manufacturer china](#)

In general, our global customers are very impressed with our services: quick response, competitive price and quality commitment. Providing more valuable technical service and a global solution is the way O-leaders move forward.

Looking to the future, O-Leading will focus on innovation and the development of electronic production technology as always and will make constant efforts on the one-stop PCB and PCBA service to provide first-class services and create more value for our customers.

Product description

Quick Info

Place of origin	Guangdong, China (mainland)	Brand name	O-leader
Basic material	FR-4, Aluminum	Copper thickness	0.5 ounces-5 ounces
Min. Hole size	0.2mm	Min. Line width	0.2mm
Surface finish	diving gold, OSP, lead-free HASL	Min. Line Spacing	0.2mm
applicable to	led, mobile phone, air conditioners, washing machines	character	Industrial control PCB
certified	ISO9001, UL, RoHS, SGS	Q / CTN	10PCS-100PCS
weight	0.01 kg -5 kg	MOQ	10 pieces
Model number	pcba manufacturer pcb assembly power bank	Thickness of the card	0.1-5mm
color	blue, red, green, black. yellow	price	\$ 0.1- \$ 10
type design	customer's requirement	cut it	0.01m3-10m3

Country of origin: [China Rigid-flexible PCB manufacturer](#)

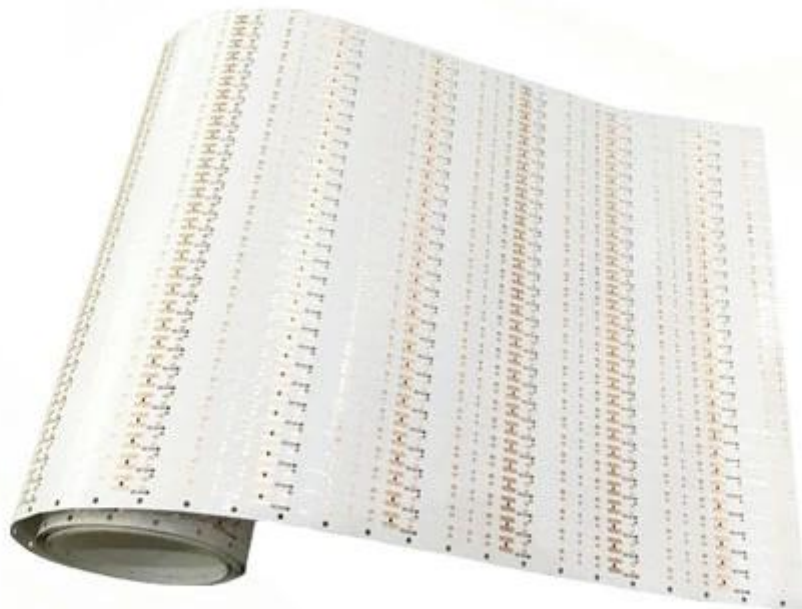
Production capacity

16 years of professional production of OEM PCB boards

article	2014		2015 ~ 2016		2017 ~ 2018	
	Volume	Sample	Volume	Sample	Volume	Sample
Counting levels	32	42	38	44	42	48
Line / min space (µm)	50/50	40/45	40/45	40/40	35/40	35/35
Hole min diameter (mm)	00:15	00:10	00:15	00:10	00:15	00:10
Proportions by PTH	14: 1	16: 1	16: 1	18: 1	18: 1	20: 1

N + C + N	4 + C + 4	5 + C + 5	5 + C + 5	6 + C + 6	5 + C + 5	6 + C + 6
Any layer interconnection	5 + 2 + 5	6 + 2 + 6	5 + 2 + 5	6 + 2 + 6	5 + 2 + 5	6 + 2 + 6
Plate filling by	YUP	-	YUP	-	YUP	-
Min. Core thickness (excluding copper) (µm)	50	40	40	30	40	30
Min. Diameter of the laser drill (µm)	75	65	65	50	50	40
Street buried hole / stacked away	YUP	-	YUP	-	YUP	-
Material	FR4, Megtron, Nelco, Rogers, Heavy Copper, etc.					
Built-in capacitor PCB	YUP	-	YUP	-	YUP	-
Surface process	Lead free HASL, ENIG, OSP, immersion silver, immersion tin, Flash gold, gold plating, selective hard gold plating, Weldable mask, carbon ink					

O-LEADING
To Be Reliable, To Be Valuable



www.o-leading.com

Our team



Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

Factory SMT



certifications

CICC INSPECTION CERTIFICATION



嘉泰认证

QUALITY MANAGEMENT SYSTEM CERTIFICATE
Certificate No: 18118Q10347R05

We hereby certify that
O-LEADING SUPPLY CHAIN(HK) CO.,LIMITED
Credit No: 61691591-000-07-18-7
Registration Add: FLAT/RM 1205 12/F TAI SANG BANK BUILDING 130-132 DES VODEUS ROAD CENTRAL HK
Business Add: 1213, Floor 13, Fortune Building, Danshui Town, Huiyang District, Huizhou, Guangdong, China

Has implemented and maintains a **Quality Management System** Which fulfills the requirements of the following standards
GB/T19001-2016 idt ISO9001:2015

Scope of certification
Sales of printed circuit boards

Initial issuance period: February 27, 2018
Renewal date: April 22, 2019
This certificate is valid during: April 22, 2019 – February 26, 2021
This certificate is invalid without CICC qualified label in the following period

First supervision and audit	Second supervision and audit	Qualified mark
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The certification registration number does not include those production stages which fail to be covered by the relevant effective administrative procedures and qualification procedures stipulated by the state. The effectiveness of this certificate shall be restricted to those activities which are covered by the certification. The actual information of this certification can be searched on the internet of CICC www.cicc.com.cn by the site of internet www.cicc.com.cn.






CICC INSPECTION CERTIFICATION



嘉泰认证

质量管理体系认证证书
证书号: 18118Q10347R05

兹证明
诚领供应链（香港）有限公司
统一社会信用代码: 61691591-000-07-18-7
注册地址: 香港中環德輔道中130-132號大生銀行大廈1205室
经营地址: 广东惠州惠阳淡水南亨西路财富大厦13楼1313

建立的质量管理体系符合
GB/T19001-2016 idt ISO9001:2015 质量标准适用条款的要求

认证范围
印刷线路板的销售

初次获证日期: 2018年02月27日
换证日期: 2019年04月22日
证书有效期: 自2019年04月22日至2021年02月26日
在下列期限内, 未经CICC黏贴合格标贴, 本证书无效

第一次监督	第二次监督	黏贴处
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本证书认证范围不包括未取得有效的国家规定的行政许可、资质许可的产品/服务范围; 本证书通过CICC定期监督审核保持, 与年度《保持认证通知书》共同方为有效; 本证书信息可在国家认监委网站: www.cnca.gov.cn及CICC网站www.cicc.com.cn查询。








ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD
 ROOM 1205, 12/F
 TAI SANG BANK BLDG
 130-132 DES VOEUS ROAD
 CENTRAL, HONG KONG

E490354

Type	Cond Width		Cond Thk	SS/ DS/ DSO	Max	Max		Meets	C		
	Min	Edge			Area	Solder	Oper			Flame	
	mm(in)	mm(in)	mic(mil)		Diam	Limits	Temp	Class	UL796	T	
Multilayer (mass laminate) printed wiring boards.											
O-LEADING-401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	
O-LEADING-407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	
Multilayer printed wiring boards.											
O-LEADING-408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
Single layer printed wiring boards.											
O-LEADING-002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING-003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
O-LEADING-033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
O-LEADING-205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING-S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING-S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲	*
O-LEADING-S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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Packaging and delivery

Shipping service



Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

Process capability

PCB production features

Layer count: 1 layer-32 layers

Finished copper thickness □ 1 / 3oz-12oz

Min line width / internal spacing □ 3.0mil / 3.0mil

Min line width / external spacing: 4.0mil / 4.0mil

Maximum aspect ratio: 10: 1

Board thickness □ 0.2mm-5.0mm

Maximum panel size (inches): 635 * 1500mm

Minimum hole size: 4mil

Plated hole tolerance: +/- 3mil

Blind / Buried Vias (All types): YES

Via Fill (conductive, non-conductive): YES

Base material: FR-4, FR-4hg Tg. Halogen-free material, Rogers, Aluminum base,polyimide,

Heavy copper

Surface finishes: HASL, OSP, ENIG, HAL-LF, silver mmmm,Immersion Tin, golden fingers, carbon ink

SMT production capacity

PCB material: FR-4, CEM-1, CEM-3, aluminum based board
Maximum PCB size: 510x460mm
Min PCB size: x 50x50mm
PCB thickness □ 0.5mm-4.5mm
Board thickness □ 0.5-4mm
Min component dimensions: 0201
Standard chip size component: 0603 and above
Maximum component height □ 15mm
Minimum lead pitch: 0.3 mm
Ball pitch BGA min: 0.4mm
Positioning accuracy: +/- 0.03 mm